

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
RILEY D. BECK	01/17/2013
MATTHEW A. TYLER	01/21/2013
KENT D. LAYTON	01/16/2013
SCOTT R. GRANGE	01/16/2013
RECEIVING PARTY DATA	
Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC
Street Address:	5005 E. MCDOWELL ROAD
Internal Address:	MAILDROP A700
City:	PHOENIX
State/Country:	ARIZONA
Postal Code:	85008
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15138534
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	ONS01274DD01
NAME OF SUBMITTER:	KELLY A. HALL
SIGNATURE:	/Kelly A. Hall/
DATE SIGNED:	04/26/2016
Total Attachments: 4	

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ASSIGNMENT & AGREEMENT

ONS01274D01

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

Name	of (City/State/Country)
Riley D. Beck	EAGLE MOUNTAIN, UTAH UNITED STATES
Kent D. Layton	LEHI, UTAH, UNITED STATES
Matthew A. Tyler	KAYSVILLE, UTAH, UNITED STATES
Scott R. Grange	PLEASANT GROVE, UTAH UNITED STATES

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

IMPEDANCE MEASURING CIRCUIT

Attorney Docket No. ONS01274D01


described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.


We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.



Kent D. Layton



Scott R. Grange

PATENT

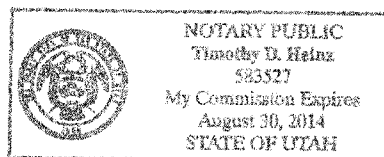
REEL: 038383 FRAME: 0868

ONS01274D01

SS. Utah
COUNTY OF Utah

Given under my hand and notarial seal this 16th day of January, 2013.

My commission expires on: 8/30/2014



ASSIGNMENT & AGREEMENT

ONS01274D01

By (Inventor signature): Riley D. Beck
Riley D. Beck

Witnessed by (Witness signature): Dan J. Clement

Printed name of Witness: Dan J. Clement

Signed and Witnessed on (date): 1/17/2013

By (Inventor signature): _____
Matthew A. Tyler

Witnessed by (Witness signature): _____

Printed name of Witness: _____

Signed and Witnessed on (date): _____

ASSIGNMENT & AGREEMENT

ONS01274D01

By (Inventor signature): _____
Riley D. Beck

Witnessed by (Witness signature): _____

Printed name of Witness: _____

Signed and Witnessed on (date): _____

By (Inventor signature): _____
Matthew A. Tyler

Witnessed by (Witness signature): _____

Printed name of Witness: _____
MARICO ONO

Signed and Witnessed on (date): _____
JAN 12/13